



Product Change Notification / ASER-26UKDT173

Date:

04-Mar-2021

Product Category:

Broadband Gateway

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4514.001 Final Notice: Qualification of MTAI as an additional assembly site for selected LE96xxx device family available in 36L VQFN (4x6x1mm) package.

Affected CPNs:

[ASER-26UKDT173_Affected_CPN_03042021.pdf](#)

[ASER-26UKDT173_Affected_CPN_03042021.csv](#)

Notification Text:

PCN Status:Final notification.

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:Qualification of MTAI as an additional assembly site for selected LE96xxx device family available in 36L VQFN (4x6x1mm) package.

Pre and Post Change Summary:

	Pre Change			Post Change			
Assembly Site	ASE Group -Malaysia (ASEM)	ASE Group Chung-Li (ASCL)	Microchip Technology Thailand (MMT)	ASE Group -Malaysia (ASEM)	ASE Group Chung-Li (ASCL)	Microchip Technology Thailand (MMT)	Microchip Technology Thailand (MTAI)

Wire material	CuPdAu	PdCu	CuPdAu	CuPdAu	PdCu	CuPdAu	CuPdAu
Die attach material	CRM1076DS	EN4900	3280	CRM1076DS	EN4900	3280	3280
Molding compound material	CEL-9240HF10A K-G1	G631H-Y	G700LTD	CEL-9240HF10A K-G1	G631H-Y	G700LTD	G700LTD
Lead frame material	C194	C194	A194	C194	C194	A194	A194
DAP Surface Prep	Ag Ring Plated	Ag Ring Plated	Ag selective Plated	Ag Ring Plated	Ag Ring Plated	Ag selective Plated	Ag selective Plated
Lead-Lock	No	No	Yes	No	No	Yes	Yes
See Pre and Post Change Summary for comparison.							

Impacts to Data Sheet:None

Change Impact:None

Reason for Change:To improve manufacturability by qualifying MTAI as an additional assembly site

Change Implementation Status:In Progress

Estimated First Ship Date:

March 1, 2021 (date code: 2110)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Due to unforeseen circumstances, that are out of Microchip's control, full qualification will be made available as soon as it is approved which may be after the estimated first ship date so that Microchip can maintain continuity of supply and not disrupt customer orders.

Time Table Summary:

	March 2021				
	1 0	1 1	1 2	1 3	14
Qual Report Availability		X			
Final PCN Issue Date	X				
Estimated Implementation Date	X				

Method to Identify Change:Traceability code

Estimated Qualification Completion Date:

March 2021

Note: This final PCN will be updated to include the Qualification report as soon as it is completed.

Revision History:

March 4, 2021: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

[PCN_ASER-26UKDT173_Pre and Post Change Summary.pdf](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to receive Microchip PCNs via email please register for our PCN email service at our [PCN home page](#) select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the [PCN FAQ](#) section.

If you wish to change your PCN profile, including opt out, please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

CCB 4514.001
Pre and Post Change Summary
Lead Frame Comparison
PCN#: ASER-26UKDT173

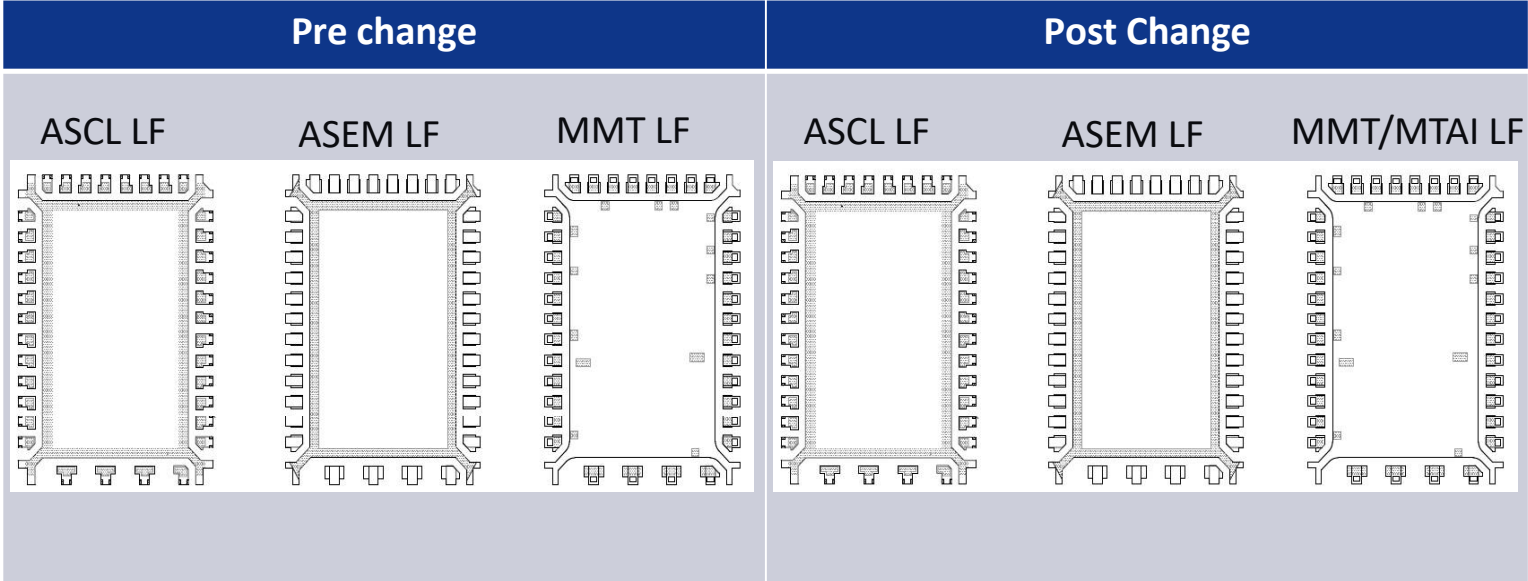


A Leading Provider of Smart, Connected and Secure Embedded Control Solutions



SMART | CONNECTED | SECURE

Lead Frame Comparison



ASER-26UKDT173 - CCB 4514.001 Final Notice: Qualification of MTAI as an additional assembly site for selected LI

Affected Catalog Part Numbers(CPN)

LE9653AQC
LE9653AQCT
LE9643AQC
LE9643AQCT